



### Features

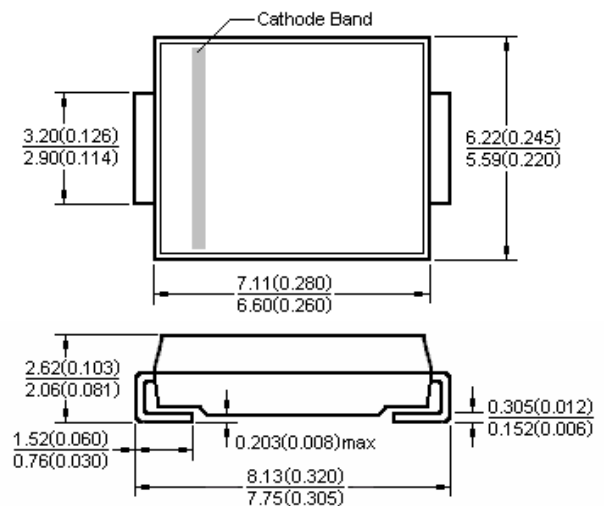
- Glass passivated chip junctions
- Ideal for automated placement
- Ultrafast reverse recovery time for high efficiency
- Low profile package
- High forward surge capability
- High temperature soldering: 260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC

### Mechanical Date

- **Case:** JEDEC DO-214AB molded plastic body over passivated chip
- **Terminals:** Solder plated, solderable per J-STD-002B and JESD22-B102D
- **Polarity:** Laser band denotes cathode end



SMC (DO - 214AB)



Dimensions in millimeters and (inches)

### Maximum Ratings and Electrical Characteristics Rating at 25 °C

ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%

Parameter	Symbols	ES3A	ES3B	ES3C	ES3D	ES3E	ES3G	ES3J	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	150	200	300	400	600	V
Maximum RMS voltage	$V_{RMS}$	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at $T_L = 100\text{ }^\circ\text{C}$	$I_{F(AV)}$	3							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	100							A
Maximum Forward Voltage at 3A	$V_F$	1.0				1.25		1.65	V
Maximum DC Reverse Current at Rated DC Blocking Voltage $T_a = 25\text{ }^\circ\text{C}$ $T_a = 125\text{ }^\circ\text{C}$	$I_R$					5			$\mu\text{A}$
						100			
Typical Junction Capacitance	$C_j$	35							pF
Maximum Reverse Recovery Time at $I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$	$t_{rr}$	35							ns
Typical Thermal Resistance <sup>2)</sup>	$R_{\theta JA}$ $R_{\theta JC}$					45			$^\circ\text{C/W}$
						15			
Operating and Storage Temperature Range	$T_j$ , $T_{stg}$	-55 ~ +150							$^\circ\text{C}$

1) Measured with  $I_F = 0.5\text{ A}$ ,  $I_R = 1\text{ A}$ ,  $I_{rr} = 0.25\text{ A}$

2) P.C.B. mounted with 0.5 X 0.5" (12.7 X 12.7 mm) copper pad areas.



# ES3A-ES3J

## Surface Mount Superfast Rectifiers

### Characteristic Curves ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

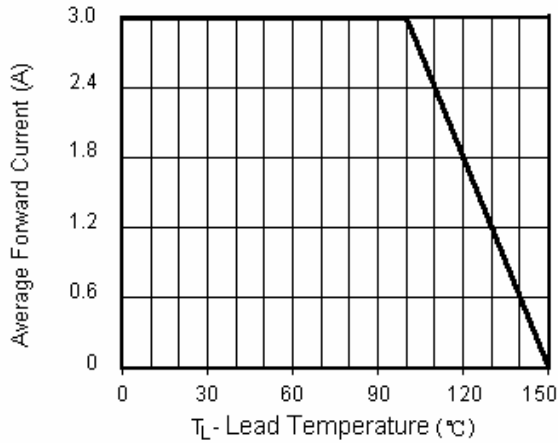


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

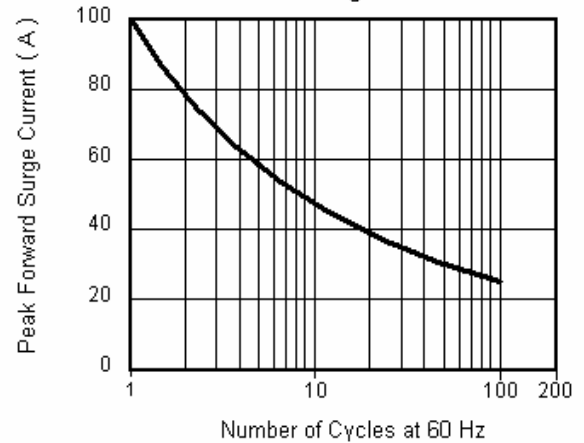


Fig.3 Typical Instantaneous Forward Characteristics

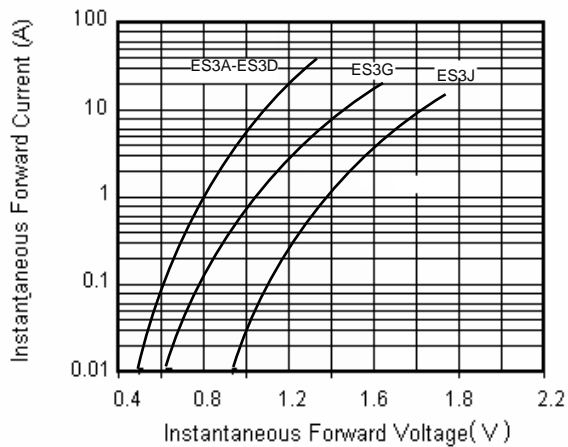
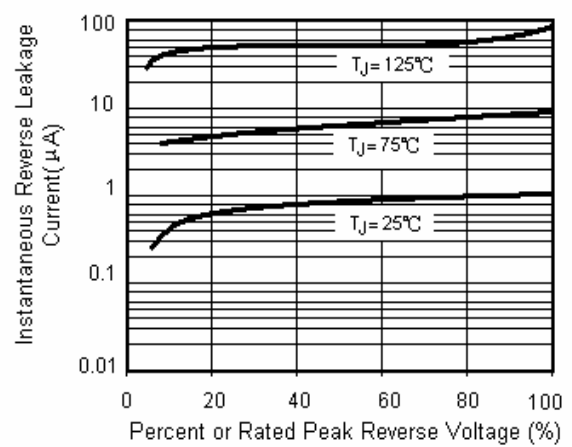


Fig.4 Typical Reverse Leakage Characteristics



## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [Rectifiers](#) category:*

*Click to view products by [Juxing Electronic Technology](#) manufacturer:*

Other Similar products are found below :

[70HFR40](#) [FR105 R0](#) [RL252-TP](#) [1N5397](#) [JANTX1N5634A](#) [1N4002G](#) [1N4005-TR](#) [JANS1N6640US](#) [481235F](#) [RRE02VS6SGTR](#) [067907F](#)  
[MS306](#) [US2JFL-TP](#) [A1N5404G-G](#) [CRS12\(T5L,TEMQ\)](#) [ACGRB207-HF](#) [CLH07\(TE16L,Q\)](#) [CLH03\(TE16L,Q\)](#) [ACGRC307-HF](#)  
[ACEFC304-HF](#) [DZ-1380](#) [NTE6356](#) [NTE6359](#) [JAN1N5555](#) [85HFR60](#) [40HFR60](#) [70HF120](#) [85HFR80](#) [D126A45C](#) [SCF7500](#) [SCHJ22.5K](#)  
[SM100](#) [SCPA2](#) [SDHD5K](#) [ACGRA4001-HF](#) [D1821SH45T PR](#) [D1251S45T](#) [NTE6358](#) [NTE5850](#) [NTE5819](#) [NTE5837](#) [NTE5892](#) [NTE5900](#)  
[NTE5911](#) [NTE5915](#) [NTE5921](#) [NTE6104](#) [NTE6105](#) [NTE6154](#) [NTE6158](#)